

IRF7495PbF

HEXFET® Power MOSFET

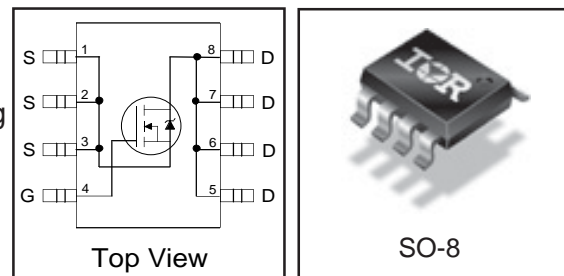
Applications

- High frequency DC-DC converters
- Lead-Free

| V_{DSS} | $R_{DS(on)}$ max | I_D |
|-----------|-------------------------------|-------|
| 100V | 22m Ω @ $V_{GS} = 10V$ | 7.3A |

Benefits

- Low Gate to Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective C_{OSS} to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|-----------------------------|--|--------------|---------------|
| V_{DS} | Drain-to-Source Voltage | 100 | V |
| V_{GS} | Gate-to-Source Voltage | ± 20 | |
| I_D @ $T_A = 25^\circ C$ | Continuous Drain Current, V_{GS} @ 10V | 7.3 | A |
| I_D @ $T_A = 100^\circ C$ | Continuous Drain Current, V_{GS} @ 10V | 4.6 | |
| I_{DM} | Pulsed Drain Current ① | 58 | |
| P_D @ $T_A = 25^\circ C$ | Maximum Power Dissipation | 2.5 | W |
| | Linear Derating Factor | 0.02 | W/ $^\circ C$ |
| dv/dt | Peak Diode Recovery dv/dt ② | 7.3 | V/ns |
| T_J | Operating Junction and | -55 to + 150 | $^\circ C$ |
| T_{STG} | Storage Temperature Range | | |

Thermal Resistance

| | Parameter | Typ. | Max. | Units |
|-----------------|-----------------------------------|------|------|--------------|
| $R_{\theta JL}$ | Junction-to-Drain Lead | — | 20 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient (PCB Mount) ③ | — | 50 | |

Notes ① through ⑥ are on page 8
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Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---------------------------------|--------------------------------------|------|------|------|------------|--|
| $V_{(BR)DSS}$ | Drain-to-Source Breakdown Voltage | 100 | — | — | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | — | 0.10 | — | V/°C | Reference to $25^\circ\text{C}, I_D = 1\text{mA}$ |
| $R_{DS(on)}$ | Static Drain-to-Source On-Resistance | — | 18 | 22 | m Ω | $V_{GS} = 10V, I_D = 4.4A$ ④ |
| $V_{GS(th)}$ | Gate Threshold Voltage | 2.0 | — | 4.0 | V | $V_{DS} = V_{GS}, I_D = 250\mu A$ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | 20 | μA | $V_{DS} = 100V, V_{GS} = 0V$ |
| | | — | — | 250 | | $V_{DS} = 80V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | 200 | nA | $V_{GS} = 20V$ |
| | Gate-to-Source Reverse Leakage | — | — | -200 | | $V_{GS} = -20V$ |

Dynamic @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|-----------------|---------------------------------|------|------|------|-------|---|
| gfs | Forward Transconductance | 11 | — | — | S | $V_{DS} = 25V, I_D = 4.4A$ |
| Q_g | Total Gate Charge | — | 34 | 51 | nC | $I_D = 4.4A$ $V_{DS} = 50V$ $V_{GS} = 10V$ ④ |
| Q_{gs} | Gate-to-Source Charge | — | 6.3 | — | | |
| Q_{gd} | Gate-to-Drain ("Miller") Charge | — | 11.7 | — | | |
| $t_{d(on)}$ | Turn-On Delay Time | — | 8.7 | — | ns | $V_{DD} = 50V$ $I_D = 4.4A$ $R_G = 6.2\Omega$ $V_{GS} = 10V$ ④ |
| t_r | Rise Time | — | 13 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 10 | — | | |
| t_f | Fall Time | — | 36 | — | | |
| C_{iss} | Input Capacitance | — | 1530 | — | pF | $V_{GS} = 0V$ |
| C_{oss} | Output Capacitance | — | 250 | — | | $V_{DS} = 25V$ |
| C_{riss} | Reverse Transfer Capacitance | — | 110 | — | | $f = 1.0\text{MHz}$ |
| C_{oss} | Output Capacitance | — | 980 | — | | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0\text{MHz}$ |
| C_{oss} | Output Capacitance | — | 160 | — | | $V_{GS} = 0V, V_{DS} = 80V, f = 1.0\text{MHz}$ |
| $C_{oss\ eff.}$ | Effective Output Capacitance | — | 240 | — | | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 80V$ ⑤ |
| | | | | | | |

Avalanche Characteristics

| | Parameter | Typ. | Max. | Units |
|----------|---------------------------------|------|------|-------|
| E_{AS} | Single Pulse Avalanche Energy ② | — | 180 | mJ |
| I_{AR} | Avalanche Current ① | — | 4.4 | A |

Diode Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|----------|---|--|------|------|-------|---|
| I_S | Continuous Source Current (Body Diode) | — | — | 2.3 | A | MOSFET symbol showing the integral reverse p-n junction diode. |
| I_{SM} | Pulsed Source Current (Body Diode) ① | — | — | 58 | | |
| V_{SD} | Diode Forward Voltage | — | — | 1.3 | V | $T_J = 25^\circ\text{C}, I_S = 4.4A, V_{GS} = 0V$ ④ |
| t_{rr} | Reverse Recovery Time | — | 42 | — | ns | $T_J = 25^\circ\text{C}, I_F = 4.4A, V_{DD} = 25V$ |
| Q_{rr} | Reverse Recovery Charge | — | 73 | — | nC | $di/dt = 100A/\mu s$ ④ |
| t_{on} | Forward Turn-On Time | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) | | | | |

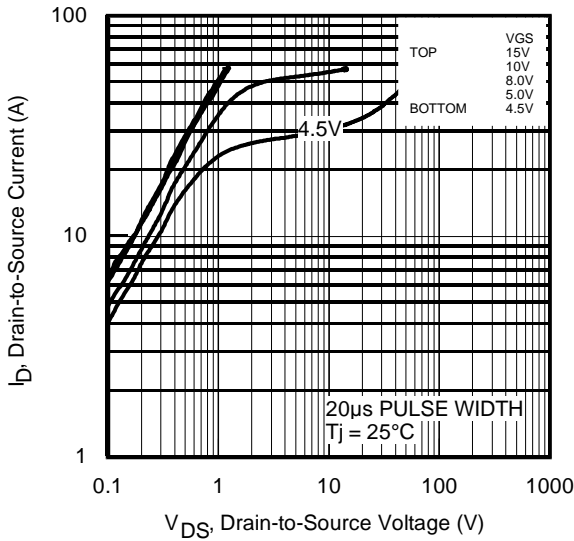


Fig 1. Typical Output Characteristics

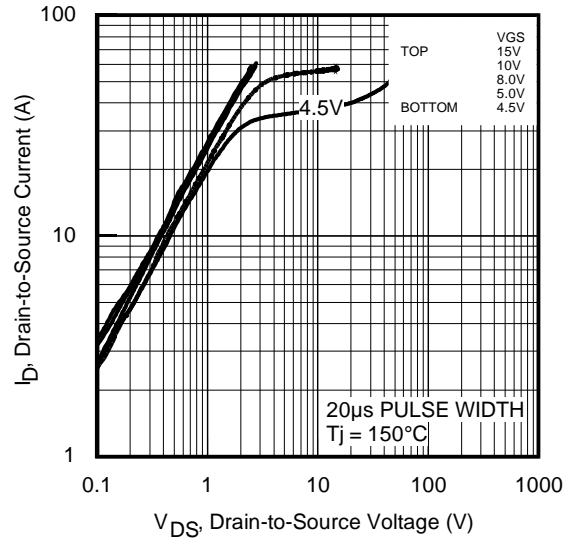


Fig 2. Typical Output Characteristics

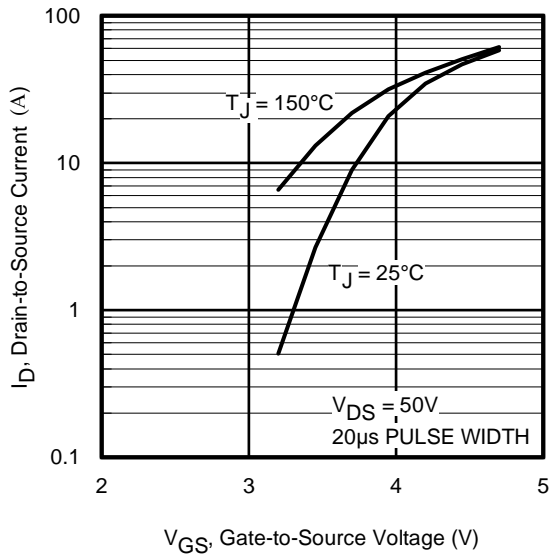


Fig 3. Typical Transfer Characteristics

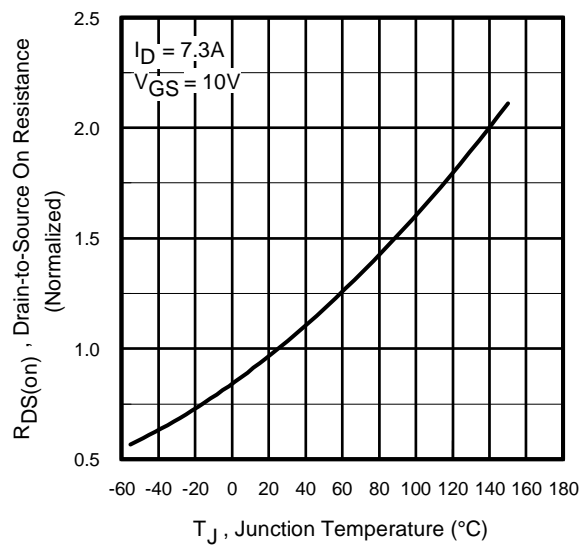


Fig 4. Normalized On-Resistance vs. Temperature

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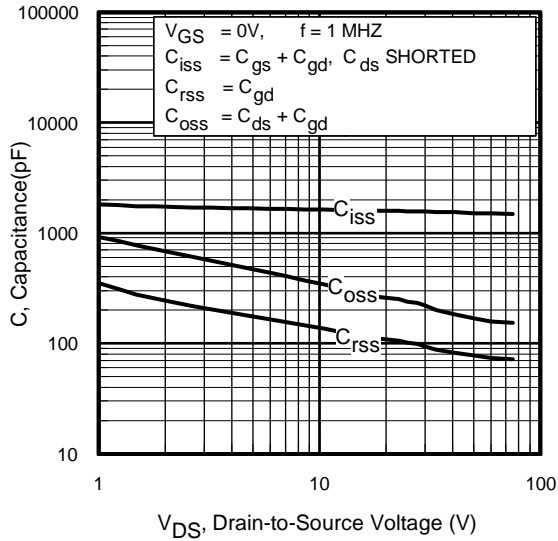


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

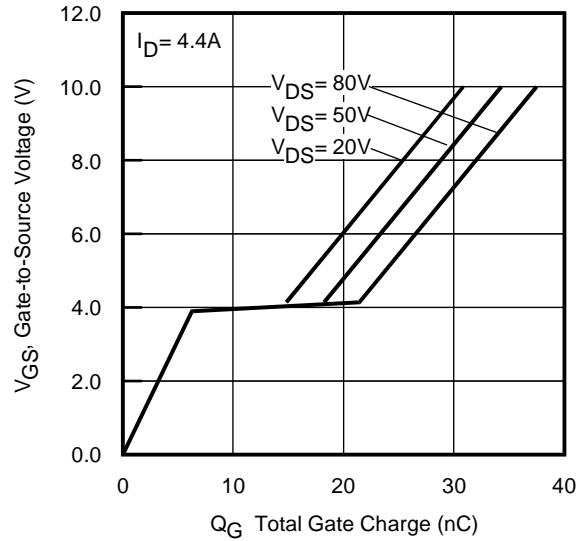


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

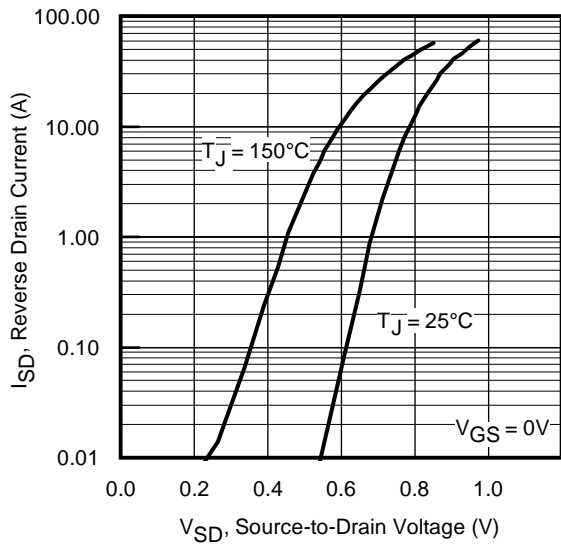


Fig 7. Typical Source-Drain Diode Forward Voltage

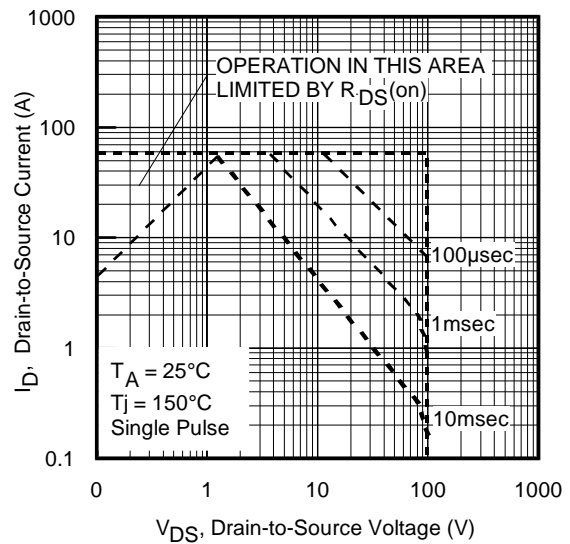


Fig 8. Maximum Safe Operating Area

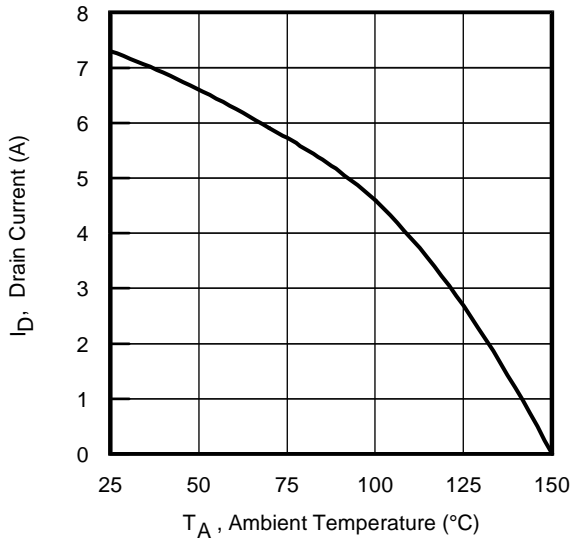


Fig 9. Maximum Drain Current vs. Ambient Temperature



Fig 10a. Switching Time Test Circuit



Fig 10b. Switching Time Waveforms

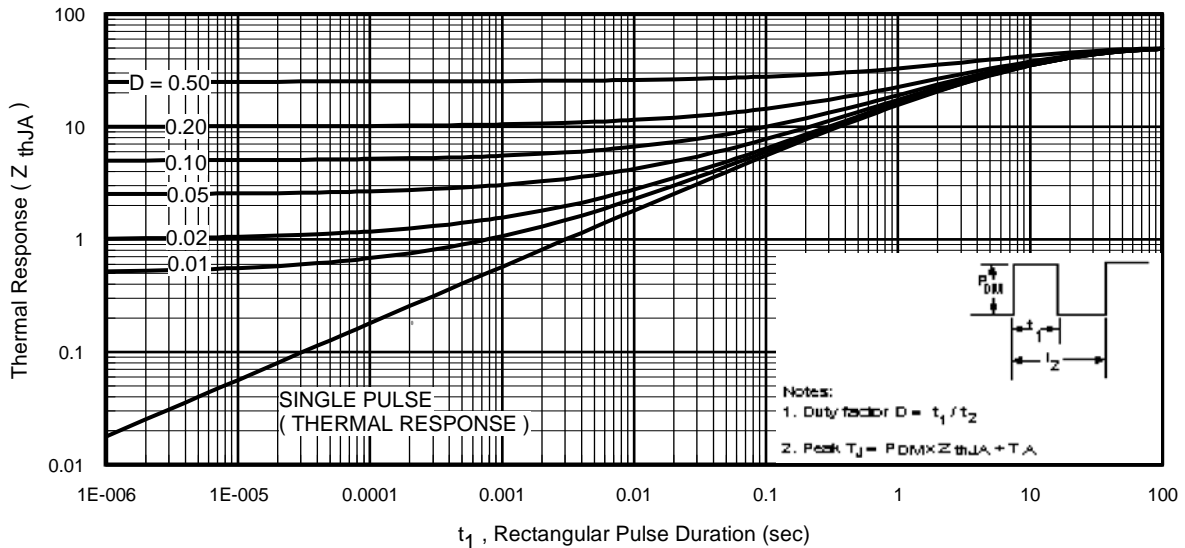


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

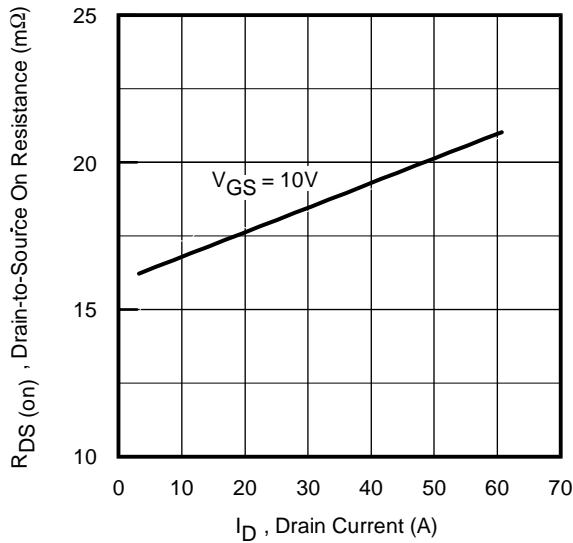


Fig 12. On-Resistance vs. Drain Current

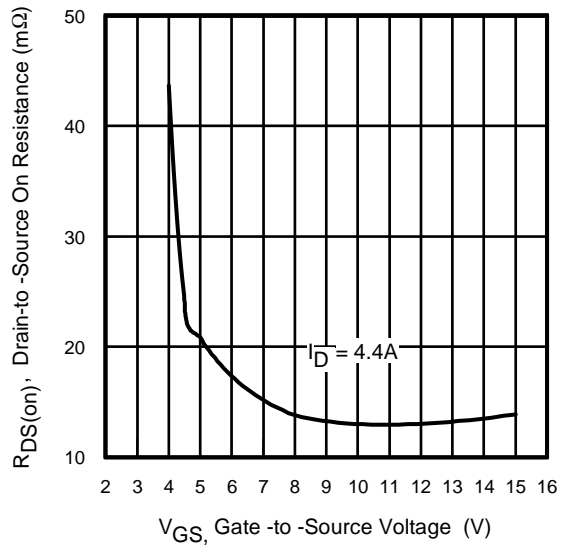


Fig 13. On-Resistance vs. Gate Voltage

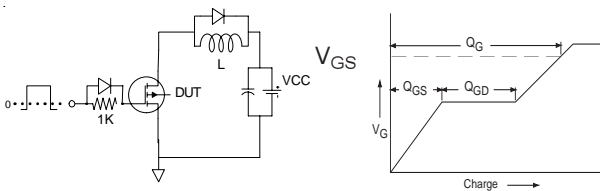


Fig 14a&b. Basic Gate Charge Test Circuit and Waveform

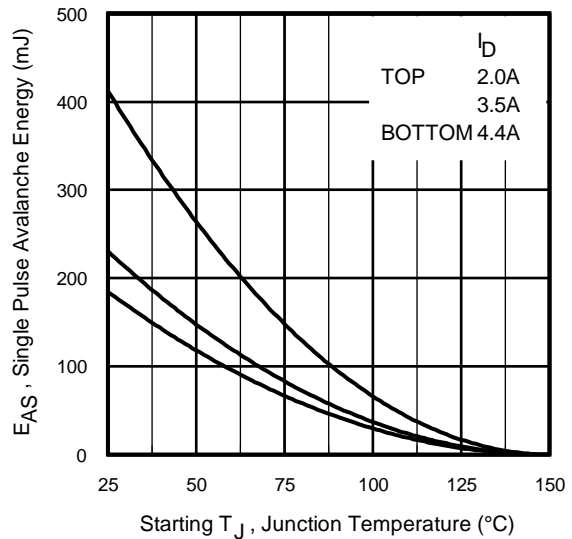


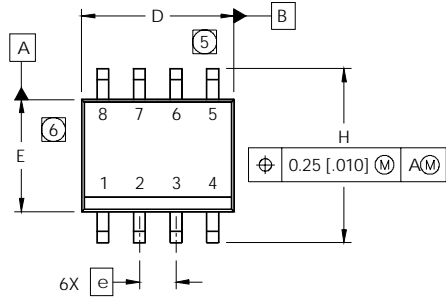
Fig 15c. Maximum Avalanche Energy vs. Drain Current



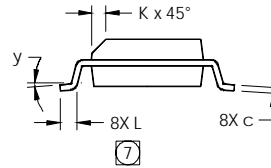
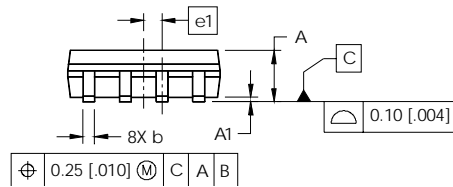
Fig 15a&b. Unclamped Inductive Test circuit and Waveforms

SO-8 Package Outline

Dimensions are shown in millimeters (inches)



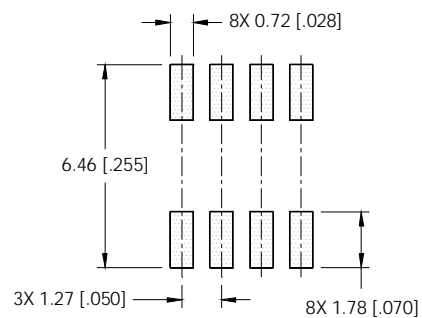
| DIM | INCHES | | MILLIMETERS | |
|-----|------------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | .0532 | .0688 | 1.35 | 1.75 |
| A1 | .0040 | .0098 | 0.10 | 0.25 |
| b | .013 | .020 | 0.33 | 0.51 |
| c | .0075 | .0098 | 0.19 | 0.25 |
| D | .189 | .1968 | 4.80 | 5.00 |
| E | .1497 | .1574 | 3.80 | 4.00 |
| e | .050 BASIC | | 1.27 BASIC | |
| e1 | .025 BASIC | | 0.635 BASIC | |
| H | .2284 | .2440 | 5.80 | 6.20 |
| K | .0099 | .0196 | 0.25 | 0.50 |
| L | .016 | .050 | 0.40 | 1.27 |
| y | 0° | 8° | 0° | 8° |



NOTES:

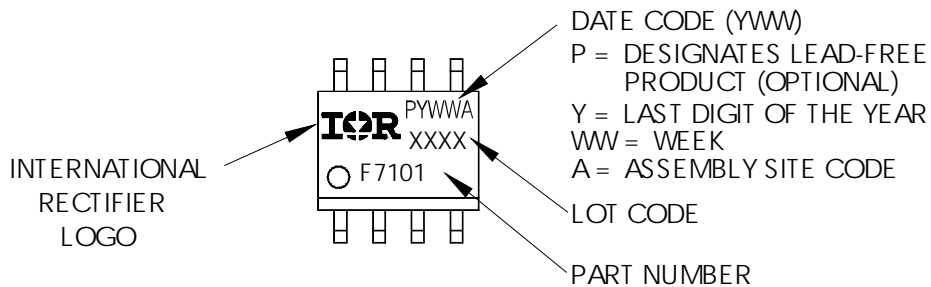
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA
- ⑤ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [0.006].
- ⑥ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [0.010].
- ⑦ DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

FOOTPRINT



SO-8 Part Marking

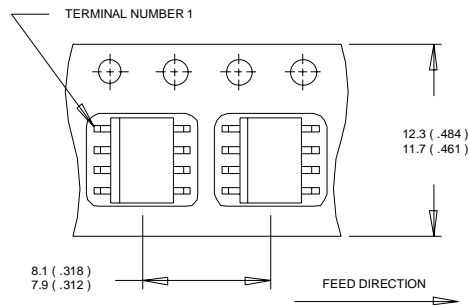
EXAMPLE: THIS IS AN IRF7101 (MOSFET)



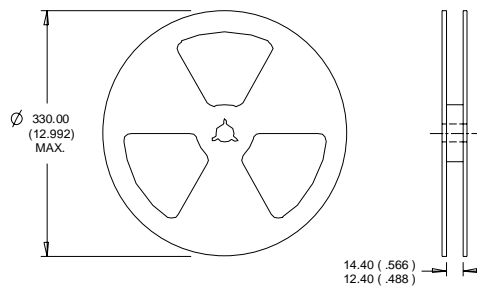
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SO-8 Tape and Reel

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- NOTES:
1. CONTROLLING DIMENSION : MILLIMETER.
 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



- NOTES:
1. CONTROLLING DIMENSION : MILLIMETER.
 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 19\text{mH}$
 $R_G = 25\Omega$, $I_{AS} = 4.4\text{A}$.
- ③ When mounted on 1 inch square copper board, $t \leq 10$ sec.
- ④ Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ⑤ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- ⑥ $I_{SD} \leq 5.8\text{A}$, $di/dt \leq 250\text{A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ\text{C}$.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Consumer market.
Qualifications Standards can be found on IR's Web site.

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IR Rectifier

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